

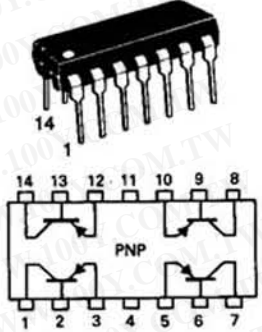


**MAXIMUM RATINGS**

Rating	Symbol	Value		Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	-40		Vdc
Collector-Base Voltage	V <sub>CBO</sub>	-40		Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	-5.0		Vdc
Collector Current — Continuous	I <sub>C</sub>	-200		mAdc
		Each Transistor	Four Transistors Equal Power	
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	500 4.0	900 7.2	mW mW/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	825 6.7	2.4 19.2	Watts mW/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		°C

**MPQ3906**

TO-116



**QUAD  
AMPLIFIER SWITCHING  
TRANSISTOR**  
PNP SILICON

**THERMAL CHARACTERISTICS**

Characteristic		Junction to Case	Junction to Ambient	Unit
Thermal Resistance	Each Die	151	250	°C/W
	Effective, 4 Die	52	139	°C/W
Coupling Factors	Q1-Q4 or Q2-Q3	34	70	%
	Q1-Q2 or Q3-Q4	2.0	26	%

**ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted.)**

Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>					
Collector-Emitter Breakdown Voltage(1) (I <sub>C</sub> = -1.0 mAdc, I <sub>B</sub> = 0)	V <sub>(BR)CEO</sub>	-40	—	—	Vdc
Collector-Base Breakdown Voltage (I <sub>C</sub> = -10 μAdc, I <sub>E</sub> = 0)	V <sub>(BR)CBO</sub>	-40	—	—	Vdc
Emitter-Base Breakdown Voltage (I <sub>E</sub> = -10 μAdc, I <sub>C</sub> = 0)	V <sub>(BR)EBO</sub>	-5.0	—	—	Vdc
Collector Cutoff Current (V <sub>CB</sub> = -30 Vdc, I <sub>E</sub> = 0)	I <sub>CBO</sub>	—	—	-50	nAdc
Emitter Cutoff Current (V <sub>EB</sub> = -4.0 Vdc, I <sub>C</sub> = 0)	I <sub>EBO</sub>	—	—	-50	nAdc

勝特力材料 886-3-5753170  
 勝特力电子(上海) 86-21-54151736  
 勝特力电子(深圳) 86-755-83298787  
[Http://www.100y.com.tw](http://www.100y.com.tw)

**ON CHARACTERISTICS(1)**

DC Current Gain (I <sub>C</sub> = -0.1 mAdc, V <sub>CE</sub> = -1.0 Vdc) (I <sub>C</sub> = -1.0 mAdc, V <sub>CE</sub> = -1.0 Vdc) (I <sub>C</sub> = -10 mAdc, V <sub>CE</sub> = -1.0 Vdc)	h <sub>FE</sub>	40 60 75	160 180 200	—	—
Collector-Emitter Saturation Voltage (I <sub>C</sub> = -10 mAdc, I <sub>B</sub> = -1.0 mAdc)	V <sub>CE(sat)</sub>	—	-0.1	-0.25	Vdc
Base-Emitter Saturation Voltage (I <sub>C</sub> = -10 mAdc, I <sub>B</sub> = -1.0 mAdc)	V <sub>BE(sat)</sub>	—	-0.65	-0.85	Vdc

**SMALL-SIGNAL CHARACTERISTICS**

Current-Gain — Bandwidth Product (I <sub>C</sub> = -10 mAdc, V <sub>CE</sub> = -20 Vdc, f = 100 MHz)	f <sub>T</sub>	200	250	—	MHz
Output Capacitance (V <sub>CB</sub> = -5.0 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)	C <sub>obo</sub>	—	3.3	4.5	pF
Input Capacitance (V <sub>EB</sub> = -0.5 Vdc, I <sub>C</sub> = 0, f = 1.0 MHz)	C <sub>ibo</sub>	—	4.8	10	pF

**SWITCHING CHARACTERISTICS**

Turn-On Time (I <sub>C</sub> = -10 mAdc, V <sub>BE(off)</sub> = 0.5 Vdc, I <sub>B1</sub> = -1.0 mAdc)	t <sub>on</sub>	—	43	—	ns
Turn-Off Time (I <sub>C</sub> = -10 mAdc, I <sub>B1</sub> = I <sub>B2</sub> = -1.0 mAdc)	t <sub>off</sub>	—	155	—	ns

(1) Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.